

Docket No.: M4065.0165/P165
(PATENT)

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of: Garry A. Mercaldi, et al.

Application No.: 09/285,773

Filed: April 5, 1999

For: METHOD FOR ETCHING DOPED

POLYSILICON WITH HIGH SELECTIVITY TO UNDOPED

POLYSILICON

Group Art Unit: 1765

Examiner: L. Umez-Eronini

## **AMENDMENT**

**Box Non-Fee Amendment** 

Commissioner for Patents Washington, DC 20231

Dear Sir:

In response to the Office Action dated December 13, 2001 (Paper No. 23), please amend the above-identified U.S. Patent application as follows:

In the Claims:

Please cancel claim 88.

Please amend claims 1, 9 and 22 as shown in the Replacement Claims:

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